

## NCE P-Channel Enhancement Mode Power MOSFET

### Description

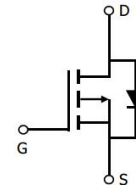
The NCE20P05Y uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

### General Features

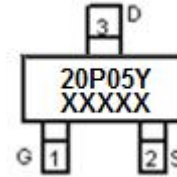
- $V_{DS} = -20V, I_D = -5A$   
 $R_{DS(ON)} < 25m\Omega @ V_{GS} = -4.5V$   
 $R_{DS(ON)} < 40m\Omega @ V_{GS} = -2.5V$
- High power and current handling capability
- Lead free product is acquired
- Surface Mount Package

### Application

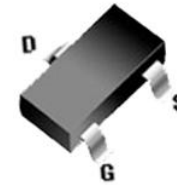
- Motor drive
- Load switch
- Power management



Schematic diagram



Marking and pin Assignment



SOT-23-3L top view

### Package Marking and Ordering Information

| Device Marking | Device    | Device Package | Reel Size | Tape width | Quantity   |
|----------------|-----------|----------------|-----------|------------|------------|
| 20P05Y         | NCE20P05Y | SOT23-3L       | Ø180mm    | 8mm        | 3000 units |

### Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter  | Symbol         | Limit      | Unit       |
|--|----------------|------------|------------|
| Drain-Source Voltage                             | $V_{DS}$       | -20        | V          |
| Gate-Source Voltage                              | $V_{GS}$       | $\pm 12$   | V          |
| Drain Current-Continuous                         | $I_D$          | -5         | A          |
| Drain Current-Pulsed (Note 1)                    | $I_{DM}$       | -20        | A          |
| Maximum Power Dissipation                        | $P_D$          | 1.5        | W          |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55 To 150 | $^\circ C$ |

### Thermal Characteristic

|  |                 |      |              |
|--|-----------------|------|--------------|
| Thermal Resistance, Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 83.3 | $^\circ C/W$ |
|--|-----------------|------|--------------|

### Electrical Characteristics ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter                       | Symbol     | Condition                  | Min | Typ | Max | Unit    |
|---------------------------------|------------|----------------------------|-----|-----|-----|---------|
| <b>Off Characteristics</b>      |            |                            |     |     |     |         |
| Drain-Source Breakdown Voltage  | $BV_{DSS}$ | $V_{GS}=0V, I_D=-250\mu A$ | -20 | -   | -   | V       |
| Zero Gate Voltage Drain Current | $I_{DSS}$  | $V_{DS}=-20V, V_{GS}=0V$   | -   | -   | -1  | $\mu A$ |

|   |              |   |      |      |           |            |
|---|--------------|---|------|------|-----------|------------|
| Gate-Body Leakage Current                 | $I_{GSS}$    | $V_{GS}=\pm 12V, V_{DS}=0V$                                     | -    | -    | $\pm 100$ | nA         |
| <b>On Characteristics</b> (Note 3)        |              |   |      |      |           |            |
| Gate Threshold Voltage                    | $V_{GS(th)}$ | $V_{DS}=V_{GS}, I_D=-250\mu A$                                  | -0.5 | -0.7 | -1.4      | V          |
| Drain-Source On-State Resistance          | $R_{DS(ON)}$ | $V_{GS}=-4.5V, I_D=-5A$   | -    | 20   | 25        | m $\Omega$ |
|   |              | $V_{GS}=-2.5V, I_D=-5A$   |      | 30   | 40        | m $\Omega$ |
| Forward Transconductance                  | $g_{FS}$     | $V_{DS}=-5V, I_D=-5A$   | -    | 17   | -         | S          |
| <b>Dynamic Characteristics</b> (Note 4)   |              |   |      |      |           |            |
| Input Capacitance                         | $C_{iss}$    | $V_{DS}=-10V, V_{GS}=0V,$<br>$F=1.0MHz$                         | -    | 2015 | -         | PF         |
| Output Capacitance                        | $C_{oss}$    |   | -    | 190  | -         | PF         |
| Reverse Transfer Capacitance              | $C_{rss}$    |   | -    | 173  | -         | PF         |
| <b>Switching Characteristics</b> (Note 4) |              |   |      |      |           |            |
| Turn-on Delay Time                        | $t_{d(on)}$  | $V_{DD}=-10V, R_L=10\Omega,$<br>$V_{GS}=-4.5V, R_{GEN}=6\Omega$ | -    | 4.5  | -         | nS         |
| Turn-on Rise Time                         | $t_r$        |   | -    | 9.2  | -         | nS         |
| Turn-Off Delay Time                       | $t_{d(off)}$ |   | -    | 18.7 | -         | nS         |
| Turn-Off Fall Time                        | $t_f$        |   | -    | 3.3  | -         | nS         |
| Total Gate Charge                         | $Q_g$        | $V_{DS}=-10V, I_D=-5A, V_{GS}=-4.5V$                            | -    | 15   | -         | nC         |
| Gate-Source Charge                        | $Q_{gs}$     |   | -    | 1.8  | -         | nC         |
| Gate-Drain Charge                         | $Q_{gd}$     |   | -    | 2.8  | -         | nC         |
| <b>Drain-Source Diode Characteristics</b> |              |   |      |      |           |            |
| Diode Forward Voltage (Note 3)            | $V_{SD}$     | $V_{GS}=0V, I_S=-5A$  | -    | -    | -1.2      | V          |

### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production

Typical Electrical and Thermal Characteristics

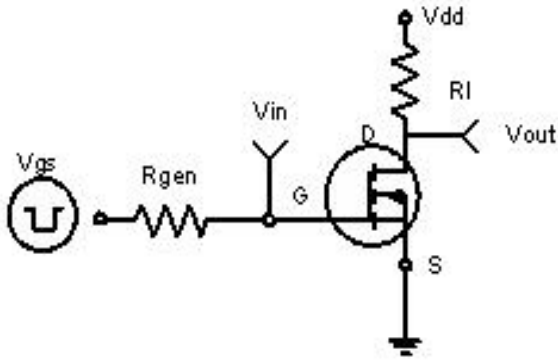


Figure 1 Switching Test Circuit

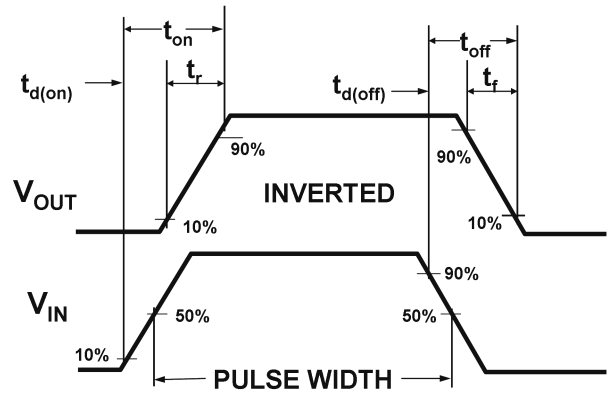


Figure 2 Switching Waveforms

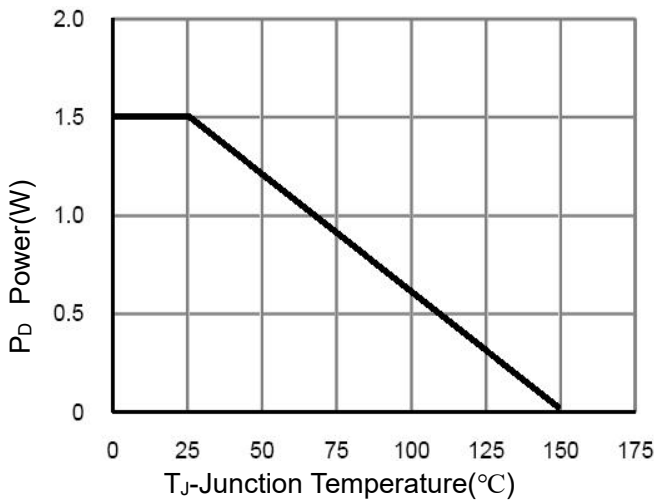


Figure 3 Power Dissipation

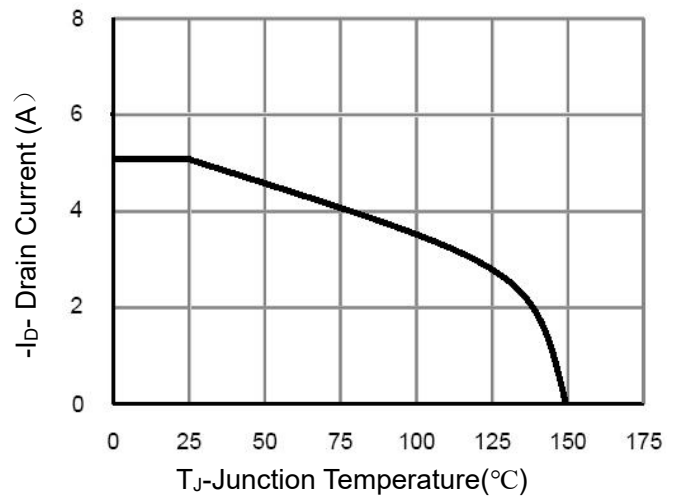


Figure 4 Drain Current

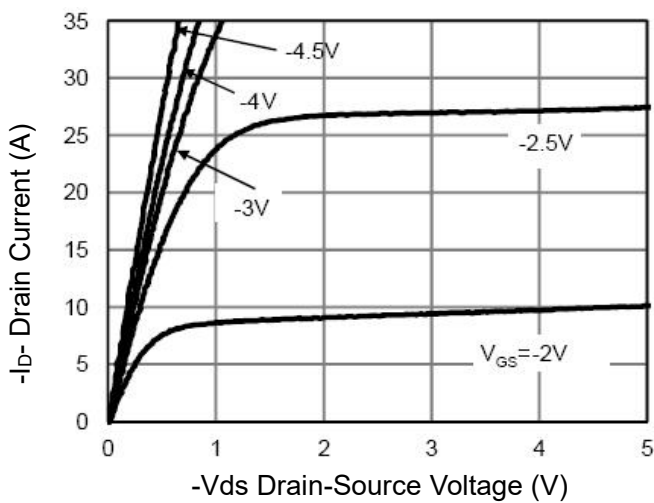


Figure 5 Output Characteristics

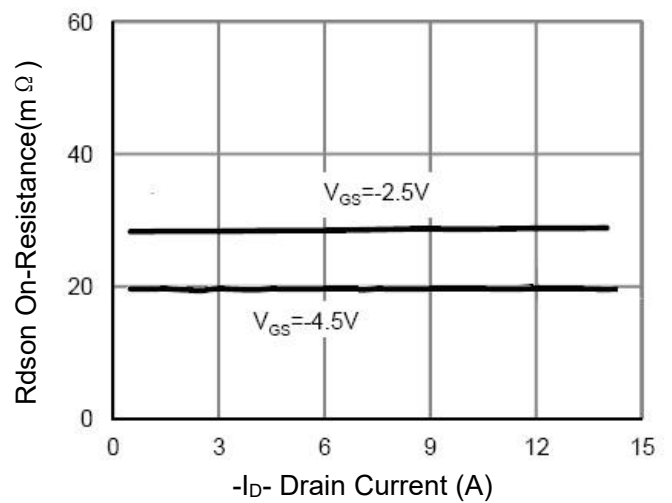


Figure 6 Drain-Source On-Resistance

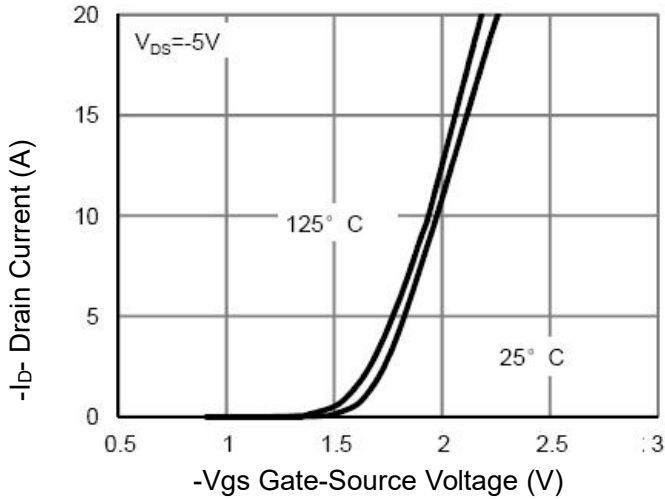


Figure 7 Transfer Characteristics

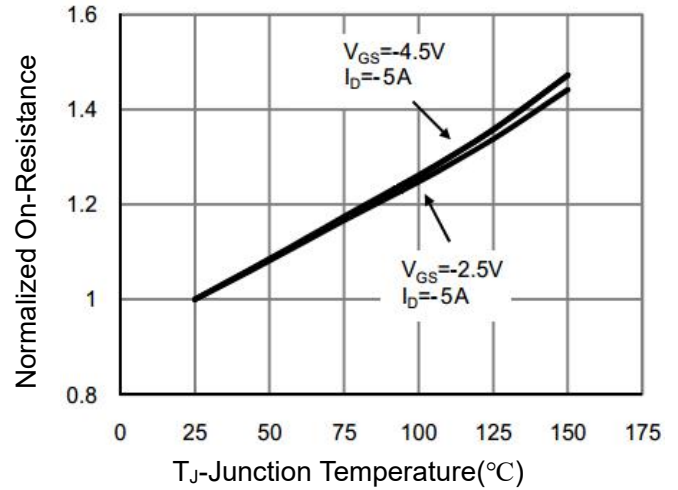


Figure 8 Drain-Source On-Resistance

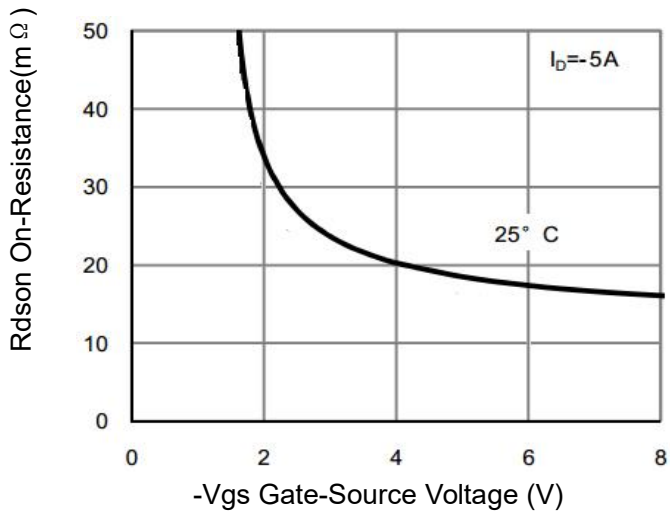


Figure 9 Rdson vs Vgs

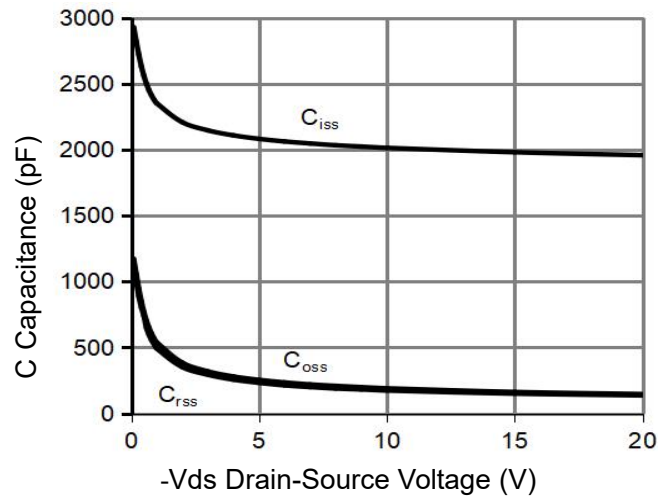


Figure 10 Capacitance vs Vds

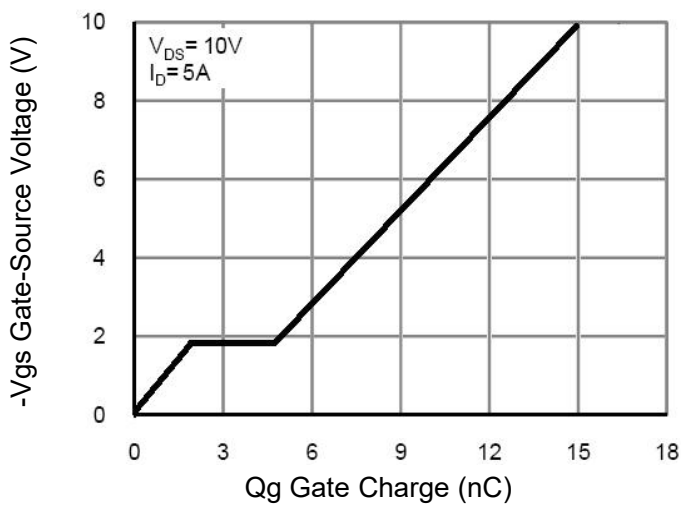


Figure 11 Gate Charge

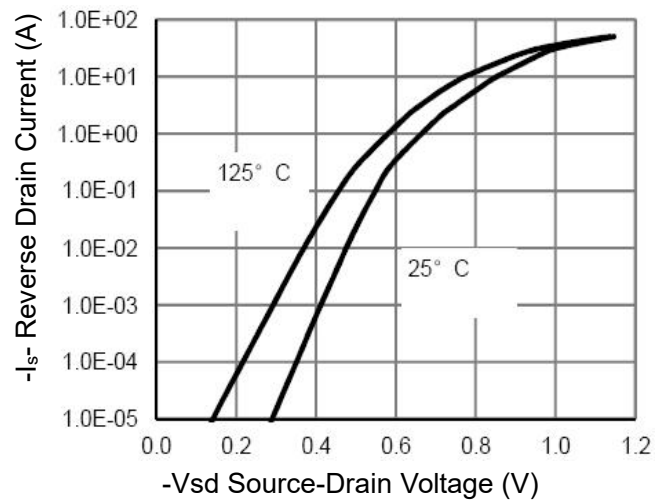


Figure 12 Source- Drain Diode Forward

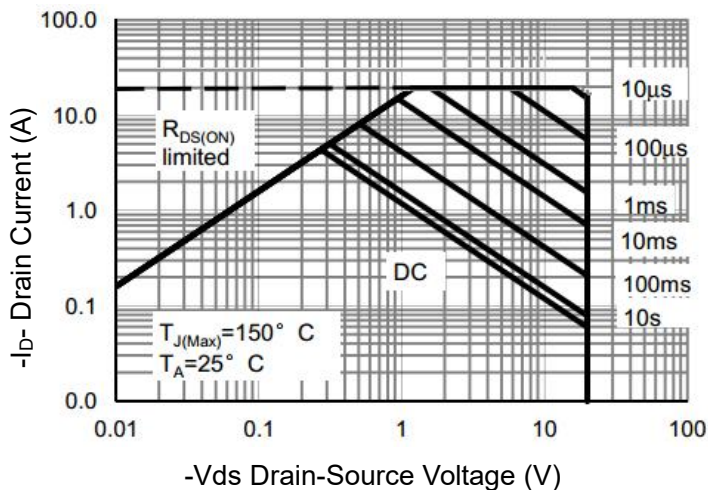


Figure 13 Safe Operation Area

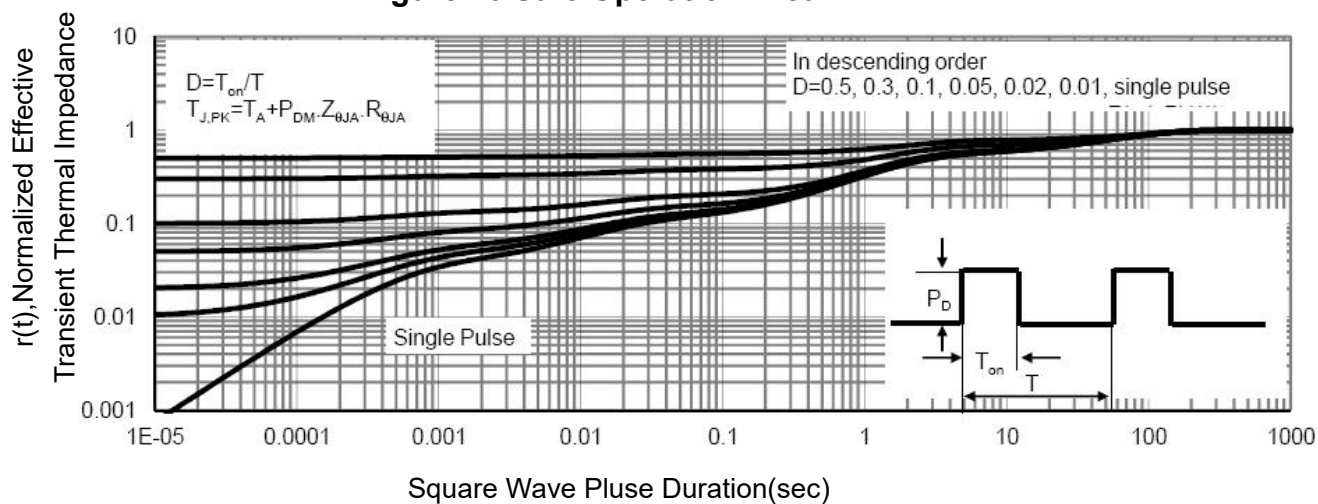
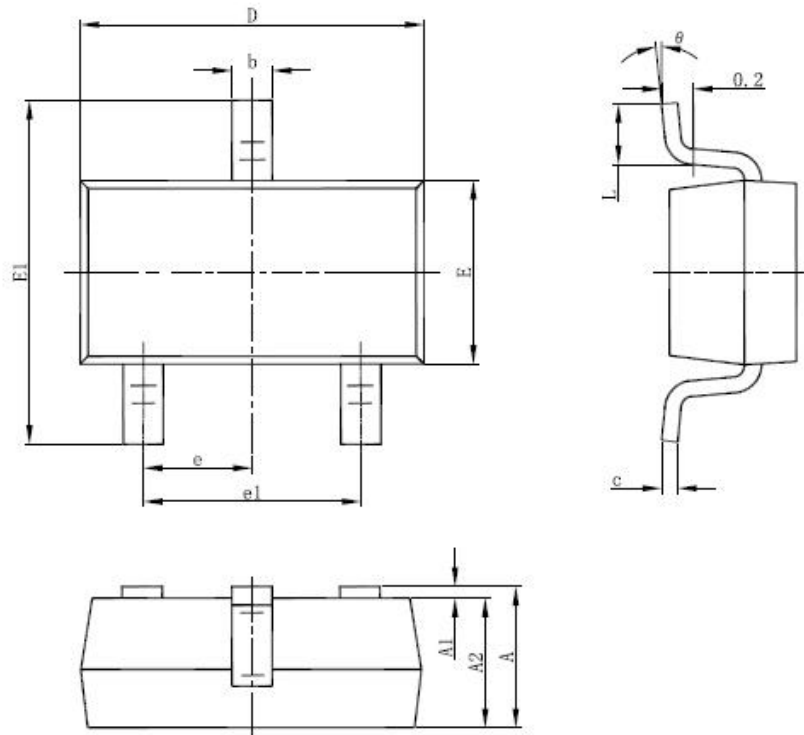


Figure 14 Normalized Maximum Transient Thermal Impedance

SOT-23-3L Package Information



| Symbol | Dimensions In Millimeters |       | Dimensions In Inches |       |
|--------|---------------------------|-------|----------------------|-------|
|        | Min                       | Max   | Min                  | Max   |
| A      | 1.050                     | 1.250 | 0.041                | 0.049 |
| A1     | 0.000                     | 0.100 | 0.000                | 0.004 |
| A2     | 1.050                     | 1.150 | 0.041                | 0.045 |
| b      | 0.300                     | 0.500 | 0.012                | 0.020 |
| c      | 0.100                     | 0.200 | 0.004                | 0.008 |
| D      | 2.820                     | 3.020 | 0.111                | 0.119 |
| E      | 1.500                     | 1.700 | 0.059                | 0.067 |
| E1     | 2.650                     | 2.950 | 0.104                | 0.116 |
| e      | 0.950(BSC)                |       | 0.037(BSC)           |       |
| e1     | 1.800                     | 2.000 | 0.071                | 0.079 |
| L      | 0.300                     | 0.600 | 0.012                | 0.024 |
| θ      | 0°                        | 8°    | 0°                   | 8°    |

Notes

1. All dimensions are in millimeters.
2. Tolerance ±0.10mm (4 mil) unless otherwise specified
3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
4. Dimension L is measured in gauge plane.
5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact

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